## KEMET Part Number: C1206X300JDGACTU

(C1206X300JDGAC7800)



## SMD Comm C0G HV Flex, Ceramic, 30 pF, 5%, 1000 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 1206



Dimensions		
L	3.3mm +/-0.4mm	
W	1.6mm +/-0.35mm	
Т	1mm +/-0.20mm	
В	0.6mm +/-0.25mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Plastic Tape	
Packaging Quantity:	2500	

General Information		
Supplier:	KEMET	
Series:	SMD Comm C0G HV Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, FT-CAP, Ultra- Stable	
Features:	FT-CAP, Ultra-Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
Chip Size:	1206	

Specifications		
Capacitance:	30 pF	
Capacitance Tolerance:	5%	
Voltage DC:	1000 VDC	
Dielectric Withstanding Voltage:	1,200 V	
Temperature Range:	-55/+125C	
Temperature Coefficient:	COG	
Dissipation Factor:	0.10% 1MHz 25C	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

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